

FPC connectors

Electronics | Connectors

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Benefits

- Reduced environmental impact due to lower carbon footprint
- Low warpage
- Low moisture absorption
- High melt temperature (325°C, 617°F)
- High glass transition temperature (125°C, 257°F)



Details

Stanyl[®] PA46 and ForTii[®] PA4T are reliable solutions for flexible printed circuit (FPC) connectors due to their high stiffness even at elevated lead-free reflow assembly temperatures with hot spots up to 300°C (572°F). For Tii offers a halogen—free alternative for ICT components that enables the latest interface technology with lower power consumption and provides higher efficiency and optimized performance.

Products

Seller represents and warrants exclusively that on the date of delivery by Seller the product shall be in conformity with the specifications agreed upon. Seller makes no other representations or warranties, whether express or implied.

Seller is not responsible or liable for the design of the products of the Customer and it is the responsibility of the Customer to determine that the Seller's product is safe, complies with application laws and regulations, and is technically or otherwise fit for its intended use. Seller does not endorse or claim suitability of its products for a specific application and disclaims each and every representation or warranty, whether express or implied, in that respect.

Typical values are indicative only and are not to be construed as being binding specifications. Colorants in the product or other additives may cause significant variations in typical